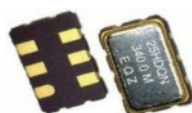


### FEATURES

- Low jitter 1.2ps phase jitter
- Wide frequency Range 10.0MHz to 1500MHz
- Very short delivery leadtimes
- Supply voltage range 2.5V or 3.3Volts
- Tristate function to conserve power



('536' package displayed)



### DESCRIPTION

'GDQF' series oscillators are a precision frequency control component, providing a LVDS output VCXO with low current consumption, a wide frequency range with an integrated phase jitter performance of 1.2ps r.m.s. The part is available in two industry-standard packages, 7 x 5mm SMD, 5 x 3.2mm SMD, and 3.2 x 2.5mm SMD.

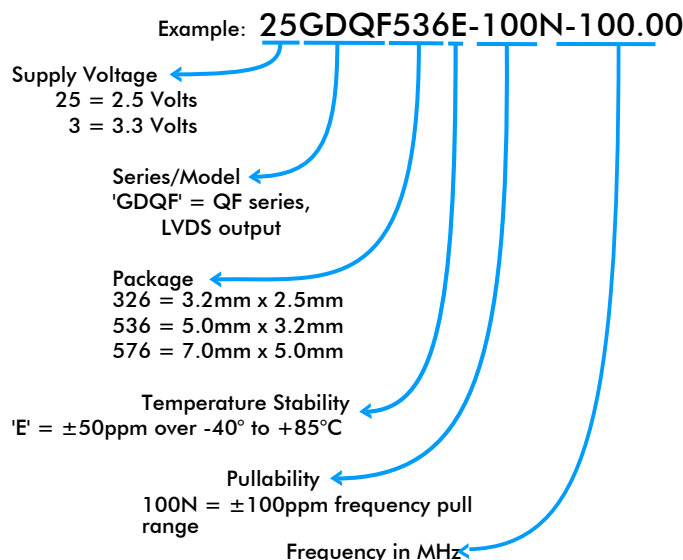
### GENERAL SPECIFICATION

Output Logic Type:	LVDS
Frequency Range:	10.0MHz to 1500MHz
Load:	100Ω between OUT and OUTN
Output Logic High:	1.4V (typ.), 1.6V (max.)
Output Logic Low:	1.1V (typ.), 0.9V (min.)
Power Supply Voltage:	2.5±5%VDC or +3.3±5%VDC
Frequency Stability:	See Stability Table
Duty Cycle:	50%±5%
Rise Time:	0.2ns minimum**
Fall Time:	0.4ns maximum**
Current Consumption @ +3.3V <sub>DD</sub>	
750.00MHz:	49mA
1GHz:	53mA
1.35GHz:	57mA
Current with output disabled:	16mA typical
Start-up Time:	10ms maximum
Ageing:	±2ppm max., first year, ±10ppm max. over 10 years.
OE Control on Pad 1	
Enable:	0.7% V <sub>DD</sub> min., or no connection
Disable:	0.3%V <sub>DD</sub> max., (high impedance).
Output Enable Time:	200ns max.
Output Disable Time:	50ns max.
Phase Jitter r.m.s.:	1.2ps typical (12kHz to 20MHz)
Storage Temperature:	-55°C to +150°C

### CONTROL VOLTAGE FUNCTION (Pad 1)

Supply Voltage (V <sub>DD</sub> )	+2.5 Volts	+3.3 Volts
VCON Centre:	+1.25 Volts	+1.65 Volts
V. Control Range:	+0.2V~+2.3V	+0.3V~+3.0V
Absolute Pulling Range (APR):	±80ppm (min.)	
Linearity:	±5% typical, ±10% max.	
Transfer Function:	Positive transfer	
Input Impedance:	1MΩ typical	
Bandwidth:	10kHz min., measured at -3dB	

### PART NUMBERING



### Notes:

- \* Stability code for ±50ppm over -40° to +85°C is 'E.' Other stabilities are available, contact Euroquartz for details.
- \* **Absolute Pull Range (APR)**  
APR guarantees the PLL remains locked (enough frequency deviation range) taking into account all the conditions of a VCXO. These conditions include frequency tolerance, frequency-temperature stability, load variation, supply voltage variation and ageing of the VCXO (known as "Total VCXO Frequency Errors"). Therefore APR in ppm = (Total frequency deviation of the VCXO in ppm) - (Total frequency errors of the VCXO in ppm)
- \*\* Rise/Fall times are measured between 10% to 90%V<sub>DD</sub>

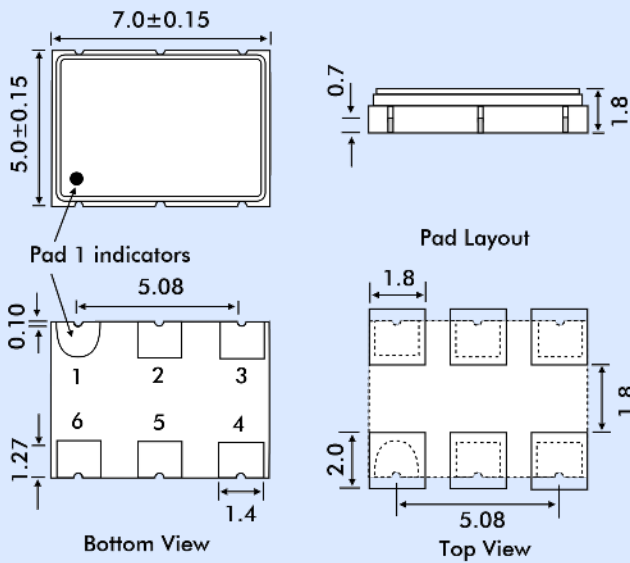
Phase Noise [dBc /Hz (typ.)]	Offset	10Hz	100Hz	1kHz	10kHz	100kHz	1MHz	10MHz
	156.250MHz	-55	-85	-109	-116	-118	-139	-146
491.52MHz	-61	-86	-100	-105	-105	-126	-137	

Frequency Stability Codes	Frequency Stability over Operating Temperature Range	±25 ppm	±50 ppm	±100 ppm	If non-standard, please enter the desired stability with a 'C' or 'I' prefix. For Example, C20 = ±20 ppm over -10°C to +70°C I20 = ±20 ppm over -40°C to +85°C
	Commercial (-10°C to +70°C)	A	B	C	
	Industrial (-40°C to +85°C)	D	E	F	

**ENVIRONMENTAL PERFORMANCE SPECIFICATION**

<b>Environmental Approvals</b>	RoHS Compliant, Pb (lead) free in accordance with EU Directive 2002/95/EC 6/6 (2002/95EC) and WEEE (2002/96/EC). Free of halide, cadmium, hexavalent chromium, lead, mercury, PBBs and PBDEs
<b>Moisture sensitivity Level</b>	Level 1 (infinite) according to IPC/JEDEC J-STF-020D.1
<b>Second Level Interconnect</b>	'e4
<b>Storage Temperature Range</b>	-55° to +125°C
<b>Humidity</b>	85%RH, 85°C, 48 hours
<b>Fine Leak / Gross Leak</b>	MIL-STD-202F Method 1014, Cond. A / MIL-STD-883, Method 1014, Cond C.
<b>Solderability</b>	MIL-STD-202F method 208E
<b>Reflow</b>	260°C for 10s. 2 times
<b>Vibration</b>	MIL-STD-202F Method 204, 35g, 50 to 2000Hz
<b>Shock</b>	MIL-STD-202F, Method 213B, Test Cond. E, 1000gg 1/2 sine wave.
<b>Resistance to Solvents</b>	MIL-STD-202, Method 215
<b>Temperature Cyscling</b>	MIL-STD-883, Method 1010
<b>ESD Rating</b>	Human Body Model (HBM): 1500 V minimum.
<b>Pad Surface Finish</b>	Gold (Au)(0.3µm ot 1.0µm) over nickel (Ni)(1.27µm to 8.89µm)
<b>Weight of the Device</b>	576 package: 0.18gm typical, 536 package: 0.09gm typical.

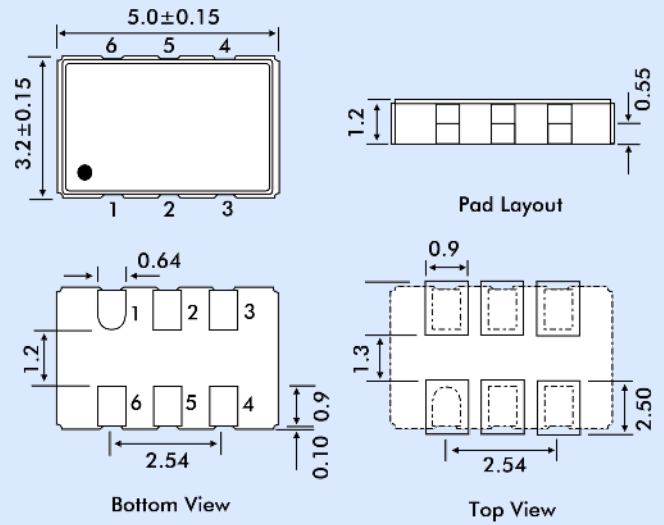
**7.0 x 5.0mm SMD Package**



**Pad Connections**

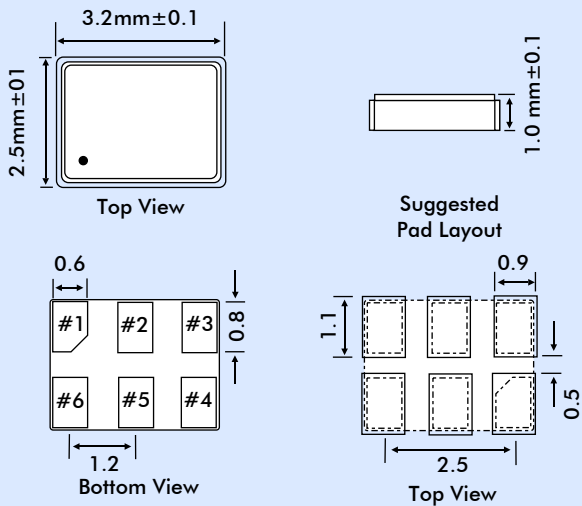
- 1 Control Voltage
- 2 OE High Enable
- 3 Ground
- 4 Output
- 5 No connection
- 6 Supply Voltage

**5.0 x 3.2mm SMD Package**



**Pad Connections**

- 1 Control Voltage
- 2 OE High Enable
- 3 Ground
- 4 Output
- 5 No connection
- 6 Supply Voltage

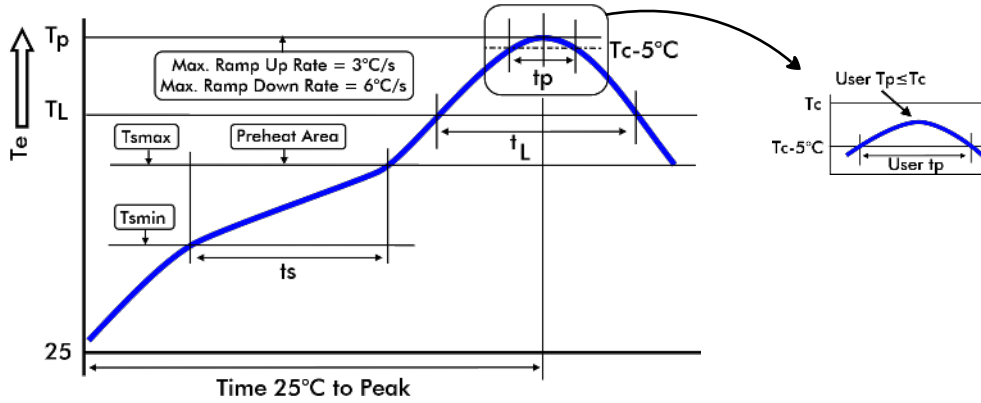


**Pad Connections**

- 1 VCXO
- 2 OE
- 3 Ground
- 4 Differential output
- 5 Complimentary Output
- 6 Supply Voltage

**RECOMMENDED SOLDER TEMPERATURE PROFILE**

Suggested Reflow Profile



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat/Soak		
- Temperature min. (Ts min.)	100°C	150°C
- Temperature max. (Ts max.)	150°C	200°
- Time (ts) (Ts min. to Ts max.)	60 to 120 seconds	60 to 180 seconds
Ramp-up Rate (Tl to Tp)	3°C/second max.	3°C/second max.
Liquidous temperature (Tl)	183°C	217°C
Time (tl) maintained above Tl	60 to 150 seconds	60 to 150 seconds
Peak package body temperature (Tp)	235°C	260°C
Time (Tp) within 5°C of the classification temperature Tc	10 to 30 seconds	20 to 40 seconds
Ramp-down rate (Tp to Tl)	6°C/second max.	6°C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.

**TEST CIRCUIT**

